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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	Cap Sense, POR, PWM, WDT
Number of I/O	17
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-VFQFN Exposed Pad
Supplier Device Package	20-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f806-gm

23.1. Port I/O Modes of Operation.....	139
23.1.1. Port Pins Configured for Analog I/O.....	139
23.1.2. Port Pins Configured For Digital I/O.....	139
23.1.3. Interfacing Port I/O to 5 V Logic.....	140
23.2. Assigning Port I/O Pins to Analog and Digital Functions.....	140
23.2.1. Assigning Port I/O Pins to Analog Functions	140
23.2.2. Assigning Port I/O Pins to Digital Functions.....	141
23.2.3. Assigning Port I/O Pins to External Digital Event Capture Functions ...	142
23.3. Priority Crossbar Decoder	143
23.4. Port I/O Initialization	147
23.5. Port Match	150
23.6. Special Function Registers for Accessing and Configuring Port I/O	152
24. Cyclic Redundancy Check Unit (CRC0).....	159
24.1. 16-bit CRC Algorithm.....	160
24.2. 32-bit CRC Algorithm.....	161
24.3. Preparing for a CRC Calculation	162
24.4. Performing a CRC Calculation	162
24.5. Accessing the CRC0 Result	162
24.6. CRC0 Bit Reverse Feature.....	166
25. Enhanced Serial Peripheral Interface (SPI0).....	167
25.1. Signal Descriptions.....	168
25.1.1. Master Out, Slave In (MOSI).....	168
25.1.2. Master In, Slave Out (MISO).....	168
25.1.3. Serial Clock (SCK)	168
25.1.4. Slave Select (NSS)	168
25.2. SPI0 Master Mode Operation	168
25.3. SPI0 Slave Mode Operation	170
25.4. SPI0 Interrupt Sources	171
25.5. Serial Clock Phase and Polarity	171
25.6. SPI Special Function Registers	173
26. SMBus.....	180
26.1. Supporting Documents	181
26.2. SMBus Configuration.....	181
26.3. SMBus Operation	181
26.3.1. Transmitter Vs. Receiver.....	182
26.3.2. Arbitration.....	182
26.3.3. Clock Low Extension.....	182
26.3.4. SCL Low Timeout.....	182
26.3.5. SCL High (SMBus Free) Timeout	183
26.4. Using the SMBus.....	183
26.4.1. SMBus Configuration Register.....	183
26.4.2. SMB0CN Control Register	187
26.4.2.1. Software ACK Generation	187
26.4.2.2. Hardware ACK Generation	187
26.4.3. Hardware Slave Address Recognition	189

List of Figures

1. System Overview

Figure 1.1. C8051F800, C8051F806, C8051F812, C8051F818 Block Diagram	16
Figure 1.2. C8051F801, C8051F807, C8051F813, C8051F819 Block Diagram	17
Figure 1.3. C8051F802, C8051F808, C8051F814, C8051F820 Block Diagram	18
Figure 1.4. C8051F803, C8051F809, C8051F815, C8051F821 Block Diagram	19
Figure 1.5. C8051F804, C8051F810, C8051F816, C8051F822 Block Diagram	20
Figure 1.6. C8051F805, C8051F811, C8051F817, C8051F823 Block Diagram	21
Figure 1.7. C8051F824, C8051F827, C8051F830, C8051F833 Block Diagram	22
Figure 1.8. C8051F825, C8051F828, C8051F831, C8051F834 Block Diagram	23
Figure 1.9. C8051F826, C8051F829, C8051F832, C8051F835 Block Diagram	24

2. Ordering Information

3. Pin Definitions

Figure 3.1. QFN-20 Pinout Diagram (Top View)	30
Figure 3.2. QSOP-24 Pinout Diagram (Top View)	31
Figure 3.3. SOIC-16 Pinout Diagram (Top View)	32

4. QFN-20 Package Specifications

Figure 4.1. QFN-20 Package Drawing	33
Figure 4.2. QFN-20 Recommended PCB Land Pattern	34

5. QSOP-24 Package Specifications

Figure 5.1. QSOP-24 Package Drawing	35
Figure 5.2. QSOP-24 PCB Land Pattern	36

6. SOIC-16 Package Specifications

Figure 6.1. SOIC-16 Package Drawing	37
Figure 6.2. SOIC-16 PCB Land Pattern	38

7. Electrical Characteristics

8. 10-Bit ADC (ADC0)

Figure 8.1. ADC0 Functional Block Diagram	46
Figure 8.2. 10-Bit ADC Track and Conversion Example Timing	48
Figure 8.3. ADC0 Equivalent Input Circuits	49
Figure 8.4. ADC Window Compare Example: Right-Justified Data	55
Figure 8.5. ADC Window Compare Example: Left-Justified Data	55
Figure 8.6. ADC0 Multiplexer Block Diagram	56

9. Temperature Sensor

Figure 9.1. Temperature Sensor Transfer Function	58
Figure 9.2. Temperature Sensor Error with 1-Point Calibration at 0 °C	59

10. Voltage and Ground Reference Options

Figure 10.1. Voltage Reference Functional Block Diagram	60
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11. Voltage Regulator (REG0)

12. Comparator0

Figure 12.1. Comparator0 Functional Block Diagram	65
Figure 12.2. Comparator Hysteresis Plot	66
Figure 12.3. Comparator Input Multiplexer Block Diagram	69

13. Capacitive Sense (CS0)

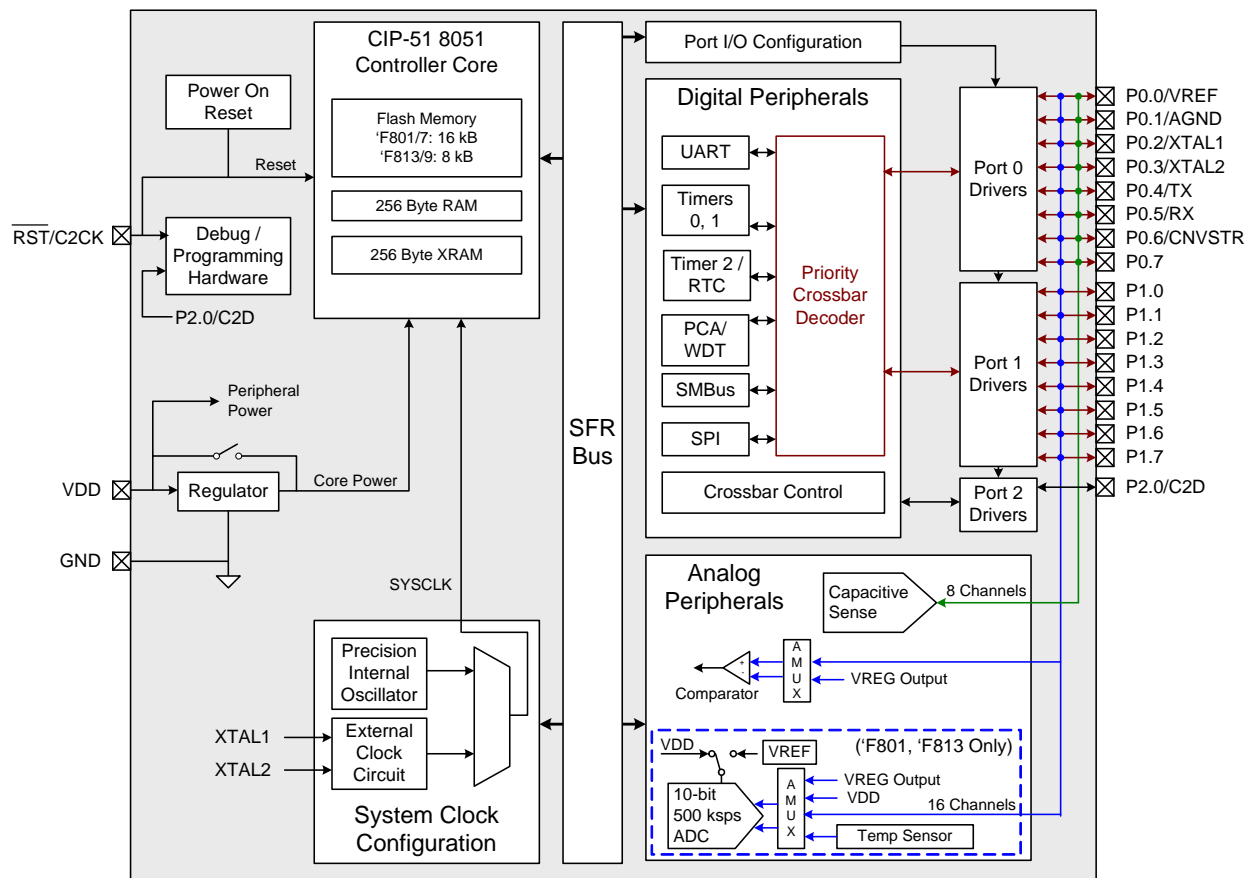


Figure 1.2. C8051F801, C8051F807, C8051F813, C8051F819 Block Diagram

C8051F80x-83x

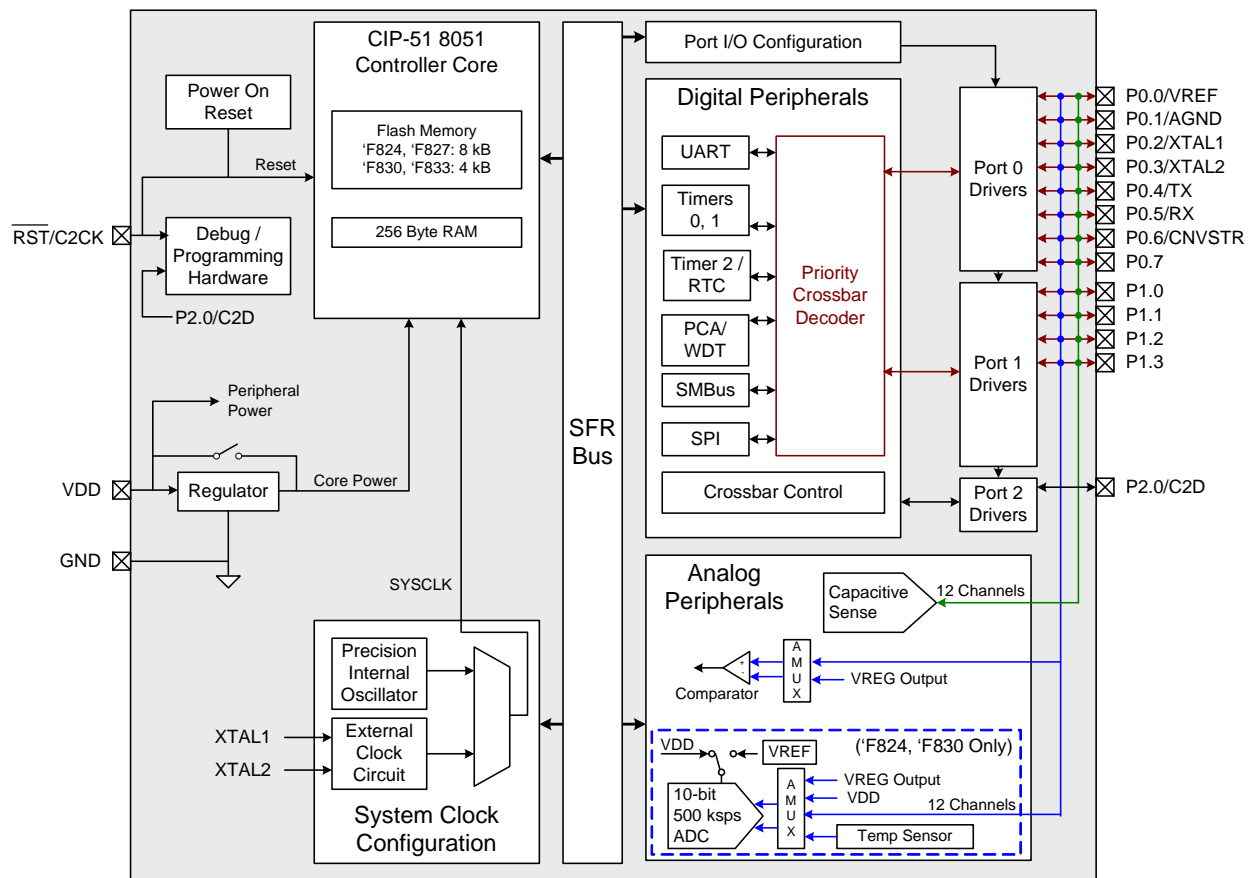


Figure 1.7. C8051F824, C8051F827, C8051F830, C8051F833 Block Diagram

3. Pin Definitions**Table 3.1. Pin Definitions for the C8051F80x-83x**

Name	Pin QSOP-24	Pin QFN-20	Pin SOIC-16	Type	Description
GND	5	2	4		Ground. This ground connection is required. The center pad may optionally be connected to ground as well on the QFN-20 packages.
V _{DD}	6	3	5		Power Supply Voltage.
$\overline{\text{RST}}$ / C2CK	7	4	6	D I/O D I/O	Device Reset. Open-drain output of internal POR or V _{DD} monitor. An external source can initiate a system reset by driving this pin low for at least 10 μ s. Clock signal for the C2 Debug Interface.
P2.0/ C2D	8	5	7	D I/O D I/O	Bi-directional data signal for the C2 Debug Interface. Shared with P2.0 on 20-pin packaging and P2.4 on 24-pin packaging. Bi-directional data signal for the C2 Debug Interface. Shared with P2.0 on 20-pin packaging and P2.4 on 24-pin packaging.
P0.0/ VREF	4	1	3	D I/O or A In A In	Port 0.0. External VREF input.
P0.1	3	20	2	D I/O or A In	Port 0.1.
P0.2/ XTAL1	2	19	1	D I/O or A In A In	Port 0.2. External Clock Input. This pin is the external oscillator return for a crystal or resonator.
P0.3/ XTAL2	23	18	16	D I/O or A In A I/O or D In	Port 0.3. External Clock Output. For an external crystal or resonator, this pin is the excitation driver. This pin is the external clock input for CMOS, capacitor, or RC oscillator configurations.
P0.4	22	17	15	D I/O or A In	Port 0.4.

C8051F80x-83x

SFR Definition 13.2. CS0CF: Capacitive Sense Configuration

Bit	7	6	5	4	3	2	1	0
Name		CS0CM[2:0]				CS0ACU[2:0]		
Type	R	R/W	R/W	R/W	R	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x9E

Bit	Name	Description
7	Unused	Read = 0b; Write = Don't care
6:4	CS0CM[2:0]	CS0 Start of Conversion Mode Select. 000: Conversion initiated on every write of 1 to CS0BUSY. 001: Conversion initiated on overflow of Timer 0. 010: Conversion initiated on overflow of Timer 2. 011: Conversion initiated on overflow of Timer 1. 100: Reserved. 101: Reserved. 110: Conversion initiated continuously after writing 1 to CS0BUSY. 111: Auto-scan enabled, conversions initiated continuously after writing 1 to CS0BUSY.
3	Unused	Read = 0b; Write = Don't care
2:0	CS0ACU[2:0]	CS0 Accumulator Mode Select. 000: Accumulate 1 sample. 001: Accumulate 4 samples. 010: Accumulate 8 samples. 011: Accumulate 16 samples 100: Accumulate 32 samples. 101: Accumulate 64 samples. 11x: Reserved.

Table 14.1. CIP-51 Instruction Set Summary

Mnemonic	Description	Bytes	Clock Cycles
Arithmetic Operations			
ADD A, Rn	Add register to A	1	1
ADD A, direct	Add direct byte to A	2	2
ADD A, @Ri	Add indirect RAM to A	1	2
ADD A, #data	Add immediate to A	2	2
ADDC A, Rn	Add register to A with carry	1	1
ADDC A, direct	Add direct byte to A with carry	2	2
ADDC A, @Ri	Add indirect RAM to A with carry	1	2
ADDC A, #data	Add immediate to A with carry	2	2
SUBB A, Rn	Subtract register from A with borrow	1	1
SUBB A, direct	Subtract direct byte from A with borrow	2	2
SUBB A, @Ri	Subtract indirect RAM from A with borrow	1	2
SUBB A, #data	Subtract immediate from A with borrow	2	2
INC A	Increment A	1	1
INC Rn	Increment register	1	1
INC direct	Increment direct byte	2	2
INC @Ri	Increment indirect RAM	1	2
DEC A	Decrement A	1	1
DEC Rn	Decrement register	1	1
DEC direct	Decrement direct byte	2	2
DEC @Ri	Decrement indirect RAM	1	2
INC DPTR	Increment Data Pointer	1	1
MUL AB	Multiply A and B	1	4
DIV AB	Divide A by B	1	8
DA A	Decimal adjust A	1	1
Logical Operations			
ANL A, Rn	AND Register to A	1	1
ANL A, direct	AND direct byte to A	2	2
ANL A, @Ri	AND indirect RAM to A	1	2
ANL A, #data	AND immediate to A	2	2
ANL direct, A	AND A to direct byte	2	2
ANL direct, #data	AND immediate to direct byte	3	3
ORL A, Rn	OR Register to A	1	1
ORL A, direct	OR direct byte to A	2	2
ORL A, @Ri	OR indirect RAM to A	1	2
ORL A, #data	OR immediate to A	2	2
ORL direct, A	OR A to direct byte	2	2
ORL direct, #data	OR immediate to direct byte	3	3
XRL A, Rn	Exclusive-OR Register to A	1	1
XRL A, direct	Exclusive-OR direct byte to A	2	2
XRL A, @Ri	Exclusive-OR indirect RAM to A	1	2
XRL A, #data	Exclusive-OR immediate to A	2	2
XRL direct, A	Exclusive-OR A to direct byte	2	2

14.2. CIP-51 Register Descriptions

Following are descriptions of SFRs related to the operation of the CIP-51 System Controller. Reserved bits should always be written to the value indicated in the SFR description. Future product versions may use these bits to implement new features in which case the reset value of the bit will be the indicated value, selecting the feature's default state. Detailed descriptions of the remaining SFRs are included in the sections of the data sheet associated with their corresponding system function.

SFR Definition 14.1. DPL: Data Pointer Low Byte

Bit	7	6	5	4	3	2	1	0
Name	DPL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x82

Bit	Name	Function
7:0	DPL[7:0]	Data Pointer Low. The DPL register is the low byte of the 16-bit DPTR.

SFR Definition 14.2. DPH: Data Pointer High Byte

Bit	7	6	5	4	3	2	1	0
Name	DPH[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x83

Bit	Name	Function
7:0	DPH[7:0]	Data Pointer High. The DPH register is the high byte of the 16-bit DPTR.

21.2. Power-Fail Reset / V_{DD} Monitor

When a power-down transition or power irregularity causes V_{DD} to drop below V_{RST} , the power supply monitor will drive the \overline{RST} pin low and hold the CIP-51 in a reset state (see Figure 21.2). When V_{DD} returns to a level above V_{RST} , the CIP-51 will be released from the reset state. Even though internal data memory contents are not altered by the power-fail reset, it is impossible to determine if V_{DD} dropped below the level required for data retention. If the PORSF flag reads 1, the data may no longer be valid. The V_{DD} monitor is enabled and selected as a reset source after power-on resets. Its defined state (enabled/disabled) is not altered by any other reset source. For example, if the V_{DD} monitor is disabled by code and a software reset is performed, the V_{DD} monitor will still be disabled after the reset.

Important Note: If the V_{DD} monitor is being turned on from a disabled state, it should be enabled before it is selected as a reset source. Selecting the V_{DD} monitor as a reset source before it is enabled and stabilized may cause a system reset. In some applications, this reset may be undesirable. If this is not desirable in the application, a delay should be introduced between enabling the monitor and selecting it as a reset source. The procedure for enabling the V_{DD} monitor and configuring it as a reset source from a disabled state is shown below:

1. Enable the V_{DD} monitor (VDMEN bit in VDM0CN = 1).
2. If necessary, wait for the V_{DD} monitor to stabilize.
3. Select the V_{DD} monitor as a reset source (PORSF bit in RSTSRC = 1).

See Figure 21.2 for V_{DD} monitor timing; note that the power-on-reset delay is not incurred after a V_{DD} monitor reset. See Section “7. Electrical Characteristics” on page 39 for complete electrical characteristics of the V_{DD} monitor.

C8051F80x-83x

SFR Definition 22.4. OSCXCN: External Oscillator Control

Bit	7	6	5	4	3	2	1	0
Name	XTLVLD	XOSCMD[2:0]				XFCN[2:0]		
Type	R	R/W			R	R/W		
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xB1

Bit	Name	Function																																				
7	XTLVLD	Crystal Oscillator Valid Flag. (Read only when XOSCMD = 11x.) 0: Crystal Oscillator is unused or not yet stable. 1: Crystal Oscillator is running and stable.																																				
6:4	XOSCMD[2:0]	External Oscillator Mode Select. 00x: External Oscillator circuit off. 010: External CMOS Clock Mode. 011: External CMOS Clock Mode with divide by 2 stage. 100: RC Oscillator Mode. 101: Capacitor Oscillator Mode. 110: Crystal Oscillator Mode. 111: Crystal Oscillator Mode with divide by 2 stage.																																				
3	Unused	Read = 0; Write = Don't Care																																				
2:0	XFCN[2:0]	External Oscillator Frequency Control Bits. Set according to the desired frequency for Crystal or RC mode. Set according to the desired K Factor for C mode.																																				
		<table><tr><th>XFCN</th><th>Crystal Mode</th><th>RC Mode</th><th>C Mode</th></tr><tr><td>000</td><td>$f \leq 32 \text{ kHz}$</td><td>$f \leq 25 \text{ kHz}$</td><td>K Factor = 0.87</td></tr><tr><td>001</td><td>$32 \text{ kHz} < f \leq 84 \text{ kHz}$</td><td>$25 \text{ kHz} < f \leq 50 \text{ kHz}$</td><td>K Factor = 2.6</td></tr><tr><td>010</td><td>$84 \text{ kHz} < f \leq 225 \text{ kHz}$</td><td>$50 \text{ kHz} < f \leq 100 \text{ kHz}$</td><td>K Factor = 7.7</td></tr><tr><td>011</td><td>$225 \text{ kHz} < f \leq 590 \text{ kHz}$</td><td>$100 \text{ kHz} < f \leq 200 \text{ kHz}$</td><td>K Factor = 22</td></tr><tr><td>100</td><td>$590 \text{ kHz} < f \leq 1.5 \text{ MHz}$</td><td>$200 \text{ kHz} < f \leq 400 \text{ kHz}$</td><td>K Factor = 65</td></tr><tr><td>101</td><td>$1.5 \text{ MHz} < f \leq 4 \text{ MHz}$</td><td>$400 \text{ kHz} < f \leq 800 \text{ kHz}$</td><td>K Factor = 180</td></tr><tr><td>110</td><td>$4 \text{ MHz} < f \leq 10 \text{ MHz}$</td><td>$800 \text{ kHz} < f \leq 1.6 \text{ MHz}$</td><td>K Factor = 664</td></tr><tr><td>111</td><td>$10 \text{ MHz} < f \leq 30 \text{ MHz}$</td><td>$1.6 \text{ MHz} < f \leq 3.2 \text{ MHz}$</td><td>K Factor = 1590</td></tr></table>	XFCN	Crystal Mode	RC Mode	C Mode	000	$f \leq 32 \text{ kHz}$	$f \leq 25 \text{ kHz}$	K Factor = 0.87	001	$32 \text{ kHz} < f \leq 84 \text{ kHz}$	$25 \text{ kHz} < f \leq 50 \text{ kHz}$	K Factor = 2.6	010	$84 \text{ kHz} < f \leq 225 \text{ kHz}$	$50 \text{ kHz} < f \leq 100 \text{ kHz}$	K Factor = 7.7	011	$225 \text{ kHz} < f \leq 590 \text{ kHz}$	$100 \text{ kHz} < f \leq 200 \text{ kHz}$	K Factor = 22	100	$590 \text{ kHz} < f \leq 1.5 \text{ MHz}$	$200 \text{ kHz} < f \leq 400 \text{ kHz}$	K Factor = 65	101	$1.5 \text{ MHz} < f \leq 4 \text{ MHz}$	$400 \text{ kHz} < f \leq 800 \text{ kHz}$	K Factor = 180	110	$4 \text{ MHz} < f \leq 10 \text{ MHz}$	$800 \text{ kHz} < f \leq 1.6 \text{ MHz}$	K Factor = 664	111	$10 \text{ MHz} < f \leq 30 \text{ MHz}$	$1.6 \text{ MHz} < f \leq 3.2 \text{ MHz}$	K Factor = 1590
		XFCN	Crystal Mode	RC Mode	C Mode																																	
		000	$f \leq 32 \text{ kHz}$	$f \leq 25 \text{ kHz}$	K Factor = 0.87																																	
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Table 23.1. Port I/O Assignment for Analog Functions

Analog Function	Potentially Assignable Port Pins	SFR(s) used for Assignment
ADC Input	P0.0–P1.7	ADC0MX, PnSKIP, PnMDIN
Comparator0 Input	P0.0–P1.7	CPT0MX, PnSKIP, PnMDIN
CS0 Input	P0.0–P1.7	CS0MX, CS0SS, CS0SE, PnMDIN
Voltage Reference (VREF0)	P0.0	REF0CN, P0SKIP, PnMDIN
Ground Reference (AGND)	P0.1	REF0CN, P0SKIP
External Oscillator in Crystal Mode (XTAL1)	P0.2	OSCXCN, P0SKIP, P0MDIN
External Oscillator in RC, C, or Crystal Mode (XTAL2)	P0.3	OSCXCN, P0SKIP, P0MDIN

23.2.2. Assigning Port I/O Pins to Digital Functions

Any Port pins not assigned to analog functions may be assigned to digital functions or used as GPIO. Most digital functions rely on the Crossbar for pin assignment; however, some digital functions bypass the Crossbar in a manner similar to the analog functions listed above. **Port pins used by these digital functions and any Port pins selected for use as GPIO should have their corresponding bit in PnSKIP set to 1.** Table 23.2 shows all available digital functions and the potential mapping of Port I/O to each digital function.

Port	P0								P1								P2
Pin Number	0	1	2	3	4	5	6	7	0	1	2	3	4 ¹	5 ¹	6 ¹	7 ¹	0
Special Function Signals	VREF	AGND	XTAL1	XTAL2			CNVSTR										
TX0																	
RX0																	
SCK																	
MISO																	
MOSI																	
NSS ²																	
SDA																	
SCL																	
CP0																	
CP0A																	
SYSCLK																	
CEX0																	
CEX1																	
CEX2																	
ECI																	
T0																	
T1																	
Pin Skip Settings	1	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	P0SKIP								P1SKIP								

In this example, the crossbar is configured to assign the UART TX0 and RX0 signals, the SPI signals, and the PCA signals. Note that the SPI signals are assigned as multiple signals. Additionally, pins P0.0, P0.2, and P0.3 are configured to be skipped using the P0SKIP register.

■ These boxes represent the port pins which are used by the peripherals in this configuration.

1st TX0 is assigned to P0.4
2nd RX0 is assigned to P0.5
3rd SCK, MISO, MOSI, and NSS are assigned to P0.1, P0.6, P0.7, and P1.0, respectively.
4th CEX0, CEX1, and CEX2 are assigned to P1.1, P1.2, and P1.3, respectively.

All unassigned pins, including those skipped by XBR0 can be used as GPIO or for other non-crossbar functions.

Notes:
1. P1.4-P1.7 are not available on 16-pin packages.
2. NSS is only pinned out when the SPI is in 4-wire mode.

Figure 23.6. Priority Crossbar Decoder Example 2—Skipping Pins

C8051F80x-83x

SFR Definition 23.2. XBR1: Port I/O Crossbar Register 1

Bit	7	6	5	4	3	2	1	0
Name	WEAKPUD	XBARE	T1E	T0E	ECIE		PCA0ME[1:0]	
Type	R/W	R/W	R/W	R/W	R/W	R	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE2

Bit	Name	Function
7	WEAKPUD	Port I/O Weak Pullup Disable. 0: Weak Pullups enabled (except for Ports whose I/O are configured for analog mode). 1: Weak Pullups disabled.
6	XBARE	Crossbar Enable. 0: Crossbar disabled. 1: Crossbar enabled.
5	T1E	T1 Enable. 0: T1 unavailable at Port pin. 1: T1 routed to Port pin.
4	T0E	T0 Enable. 0: T0 unavailable at Port pin. 1: T0 routed to Port pin.
3	ECIE	PCA0 External Counter Input Enable. 0: ECI unavailable at Port pin. 1: ECI routed to Port pin.
2	Unused	Read = 0b; Write = Don't Care.
1:0	PCA0ME[1:0]	PCA Module I/O Enable Bits. 00: All PCA I/O unavailable at Port pins. 01: CEX0 routed to Port pin. 10: CEX0, CEX1 routed to Port pins. 11: CEX0, CEX1, CEX2 routed to Port pins.

SFR Definition 23.8. P0MDIN: Port 0 Input Mode

Bit	7	6	5	4	3	2	1	0
Name	P0MDIN[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF1

Bit	Name	Function
7:0	P0MDIN[7:0]	Analog Configuration Bits for P0.7–P0.0 (respectively). Port pins configured for analog mode have their weak pullup, digital driver, and digital receiver disabled. In order for the P0.n pin to be in analog mode, there MUST be a '1' in the Port Latch register corresponding to that pin. 0: Corresponding P0.n pin is configured for analog mode. 1: Corresponding P0.n pin is not configured for analog mode.

SFR Definition 23.9. P0MDOUT: Port 0 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P0MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA4

Bit	Name	Function
7:0	P0MDOUT[7:0]	Output Configuration Bits for P0.7–P0.0 (respectively). These bits are ignored if the corresponding bit in register P0MDIN is logic 0. 0: Corresponding P0.n Output is open-drain. 1: Corresponding P0.n Output is push-pull.

is set. While the SPI0 master transfers data to a slave on the MOSI line, the addressed SPI slave device simultaneously transfers the contents of its shift register to the SPI master on the MISO line in a full-duplex operation. Therefore, the SPIF flag serves as both a transmit-complete and receive-data-ready flag. The data byte received from the slave is transferred MSB-first into the master's shift register. When a byte is fully shifted into the register, it is moved to the receive buffer where it can be read by the processor by reading SPI0DAT.

When configured as a master, SPI0 can operate in one of three different modes: multi-master mode, 3-wire single-master mode, and 4-wire single-master mode. The default, multi-master mode is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 1. In this mode, NSS is an input to the device, and is used to disable the master SPI0 when another master is accessing the bus. When NSS is pulled low in this mode, MSTEN (SPI0CN.6) and SPIEN (SPI0CN.0) are set to 0 to disable the SPI master device, and a Mode Fault is generated (MODF, SPI0CN.5 = 1). Mode Fault will generate an interrupt if enabled. SPI0 must be manually re-enabled in software under these circumstances. In multi-master systems, devices will typically default to being slave devices while they are not acting as the system master device. In multi-master mode, slave devices can be addressed individually (if needed) using general-purpose I/O pins. Figure 25.2 shows a connection diagram between two master devices in multiple-master mode.

3-wire single-master mode is active when NSSMD1 (SPI0CN.3) = 0 and NSSMD0 (SPI0CN.2) = 0. In this mode, NSS is not used, and is not mapped to an external port pin through the crossbar. Any slave devices that must be addressed in this mode should be selected using general-purpose I/O pins. Figure 25.3 shows a connection diagram between a master device in 3-wire master mode and a slave device.

4-wire single-master mode is active when NSSMD1 (SPI0CN.3) = 1. In this mode, NSS is configured as an output pin, and can be used as a slave-select signal for a single SPI device. In this mode, the output value of NSS is controlled (in software) with the bit NSSMD0 (SPI0CN.2). Additional slave devices can be addressed using general-purpose I/O pins. Figure 25.4 shows a connection diagram for a master device in 4-wire master mode and two slave devices.

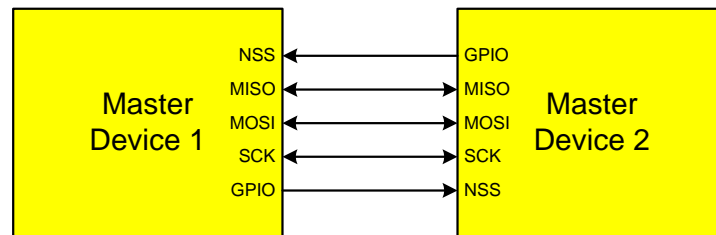


Figure 25.2. Multiple-Master Mode Connection Diagram

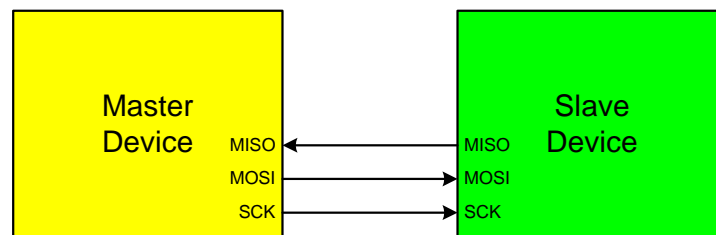
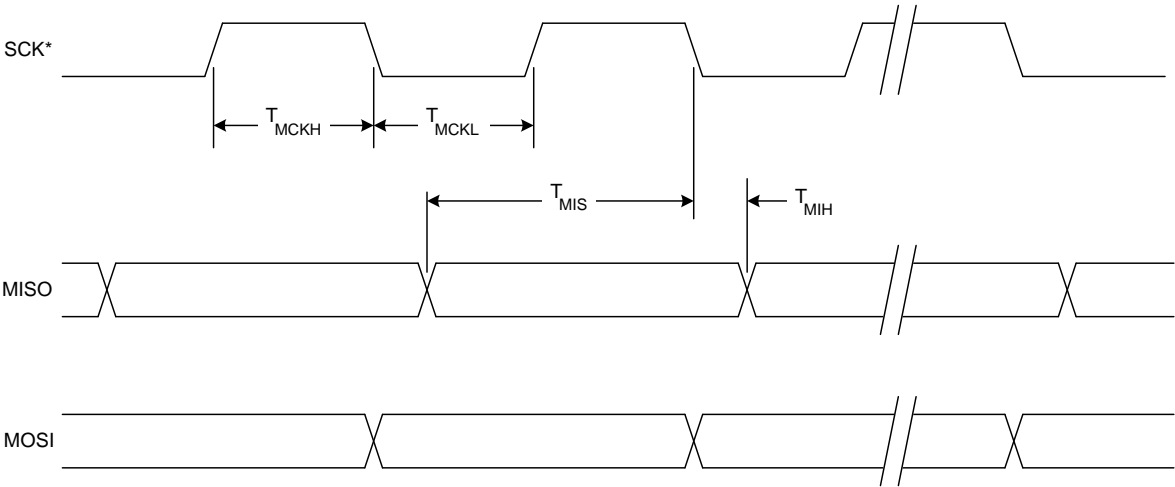
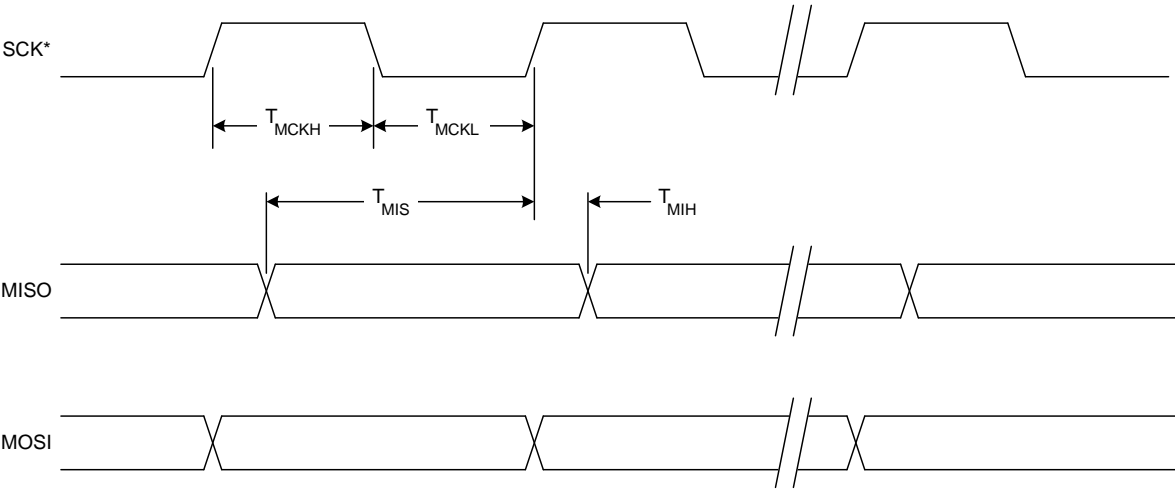


Figure 25.3. 3-Wire Single Master and 3-Wire Single Slave Mode Connection Diagram



* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 25.8. SPI Master Timing (CKPHA = 0)



* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 25.9. SPI Master Timing (CKPHA = 1)

C8051F80x-83x

SFR Definition 28.1. CKCON: Clock Control

Bit	7	6	5	4	3	2	1	0
Name			T2MH	T2ML	T1M	T0M	SCA[1:0]	
Type	R	R	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0x8E

Bit	Name	Function
7:6	Unused	Read = 0b; Write = Don't care
5	T2MH	Timer 2 High Byte Clock Select. Selects the clock supplied to the Timer 2 high byte (split 8-bit timer mode only). 0: Timer 2 high byte uses the clock defined by the T2XCLK bit in TMR2CN. 1: Timer 2 high byte uses the system clock.
4	T2ML	Timer 2 Low Byte Clock Select. Selects the clock supplied to Timer 2. If Timer 2 is configured in split 8-bit timer mode, this bit selects the clock supplied to the lower 8-bit timer. 0: Timer 2 low byte uses the clock defined by the T2XCLK bit in TMR2CN. 1: Timer 2 low byte uses the system clock.
3	T1	Timer 1 Clock Select. Selects the clock source supplied to Timer 1. Ignored when C/T1 is set to 1. 0: Timer 1 uses the clock defined by the prescale bits SCA[1:0]. 1: Timer 1 uses the system clock.
2	T0	Timer 0 Clock Select. Selects the clock source supplied to Timer 0. Ignored when C/T0 is set to 1. 0: Counter/Timer 0 uses the clock defined by the prescale bits SCA[1:0]. 1: Counter/Timer 0 uses the system clock.
1:0	SCA[1:0]	Timer 0/1 Prescale Bits. These bits control the Timer 0/1 Clock Prescaler: 00: System clock divided by 12 01: System clock divided by 4 10: System clock divided by 48 11: External clock divided by 8 (synchronized with the system clock)

30. C2 Interface

C8051F80x-83x devices include an on-chip Silicon Labs 2-Wire (C2) debug interface to allow Flash programming and in-system debugging with the production part installed in the end application. The C2 interface operates using only two pins: a bi-directional data signal (C2D), and a clock input (C2CK). See the C2 Interface Specification for details on the C2 protocol.

30.1. C2 Interface Registers

The following describes the C2 registers necessary to perform Flash programming functions through the C2 interface. All C2 registers are accessed through the C2 interface as described in the C2 Interface Specification.

C2 Register Definition 30.1. C2ADD: C2 Address

Bit	7	6	5	4	3	2	1	0
Name	C2ADD[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

Bit	Name	Function																																	
7:0	C2ADD[7:0]	<p>C2 Address.</p> <p>The C2ADD register is accessed via the C2 interface to select the target Data register for C2 Data Read and Data Write commands.</p> <table> <tr> <th>Address</th><th>Name</th><th>Description</th></tr> <tr> <td>0x00</td><td>DEVICEID</td><td>Selects the Device ID Register (read only)</td></tr> <tr> <td>0x01</td><td>REVID</td><td>Selects the Revision ID Register (read only)</td></tr> <tr> <td>0x02</td><td>FPCTL</td><td>Selects the C2 Flash Programming Control Register</td></tr> <tr> <td>0xBF</td><td>FPDAT</td><td>Selects the C2 Flash Data Register</td></tr> <tr> <td>0xD2</td><td>CRC0AUTO*</td><td>Selects the CRC0AUTO Register</td></tr> <tr> <td>0xD3</td><td>CRC0CNT*</td><td>Selects the CRC0CNT Register</td></tr> <tr> <td>0xCE</td><td>CRC0CN*</td><td>Selects the CRC0CN Register</td></tr> <tr> <td>0xDE</td><td>CRC0DATA*</td><td>Selects the CRC0DATA Register</td></tr> <tr> <td>0xCF</td><td>CRC0FLIP*</td><td>Selects the CRC0FLIP Register</td></tr> <tr> <td>0xDD</td><td>CRC0IN*</td><td>Selects the CRC0IN Register</td></tr> </table>	Address	Name	Description	0x00	DEVICEID	Selects the Device ID Register (read only)	0x01	REVID	Selects the Revision ID Register (read only)	0x02	FPCTL	Selects the C2 Flash Programming Control Register	0xBF	FPDAT	Selects the C2 Flash Data Register	0xD2	CRC0AUTO*	Selects the CRC0AUTO Register	0xD3	CRC0CNT*	Selects the CRC0CNT Register	0xCE	CRC0CN*	Selects the CRC0CN Register	0xDE	CRC0DATA*	Selects the CRC0DATA Register	0xCF	CRC0FLIP*	Selects the CRC0FLIP Register	0xDD	CRC0IN*	Selects the CRC0IN Register
Address	Name	Description																																	
0x00	DEVICEID	Selects the Device ID Register (read only)																																	
0x01	REVID	Selects the Revision ID Register (read only)																																	
0x02	FPCTL	Selects the C2 Flash Programming Control Register																																	
0xBF	FPDAT	Selects the C2 Flash Data Register																																	
0xD2	CRC0AUTO*	Selects the CRC0AUTO Register																																	
0xD3	CRC0CNT*	Selects the CRC0CNT Register																																	
0xCE	CRC0CN*	Selects the CRC0CN Register																																	
0xDE	CRC0DATA*	Selects the CRC0DATA Register																																	
0xCF	CRC0FLIP*	Selects the CRC0FLIP Register																																	
0xDD	CRC0IN*	Selects the CRC0IN Register																																	
<p>*Note: CRC registers and functions are described in Section “24. Cyclic Redundancy Check Unit (CRC0)” on page 159.</p>																																			

C8051F80x-83x

C2 Register Definition 30.2. DEVICEID: C2 Device ID

Bit	7	6	5	4	3	2	1	0
Name	DEVICEID[7:0]							
Type	R/W							
Reset	1	1	1	0	0	0	0	1

C2 Address: 0x00

Bit	Name	Function
7:0	DEVICEID[7:0]	Device ID. This read-only register returns the 8-bit device ID: 0x23 (C8051F80x-83x).

C2 Register Definition 30.3. REVID: C2 Revision ID

Bit	7	6	5	4	3	2	1	0
Name	REVID[7:0]							
Type	R/W							
Reset	Varies	Varies	Varies	Varies	Varies	Varies	Varies	Varies

C2 Address: 0x01

Bit	Name	Function
7:0	REVID[7:0]	Revision ID. This read-only register returns the 8-bit revision ID. For example: 0x00 = Revision A.

C8051F80x-83x

NOTES: